



BSI Standards Publication

Semiconductor devices — Mechanical and climatic test methods —

Part 20: Resistance of plastic encapsulated
SMDs to the combined effect of moisture and
soldering heat

National foreword

This British Standard is the UK implementation of EN 60749-20:2009. It is identical to IEC 60749-20:2008. It supersedes BS EN 60749-20:2003 which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/47, Semiconductors.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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Amendments issued since publication

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